## **Board Stack Report**

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.036mm	
5		Dielectric 1	Polyamide	0.127mm	4.2
6		L2	Copper	0.036mm	
7		Dielectric 2	Polyamide	0.127mm	4.2
8		L3	Copper	0.036mm	
9		Dielectric 3	FR4	1.200mm	4.2
10		Bottom Layer	Copper	0.036mm	
11		<b>Bottom Solder</b>	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		<b>Bottom Paste</b>			
	Height : 1.617mm				